

# **FDMS86105** N-Channel PowerTrench<sup>®</sup> MOSFET 100 V, 26 A, 34 m $\Omega$

### Features

- Max  $r_{DS(on)} = 34 \text{ m}\Omega \text{ at } V_{GS} = 10 \text{ V}, I_D = 6 \text{ A}$
- Max  $r_{DS(on)} = 54 \text{ m}\Omega \text{ at } V_{GS} = 6 \text{ V}, I_D = 4.5 \text{ A}$
- Advanced package and silicon combination for low r<sub>DS(on)</sub> and high efficiency
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

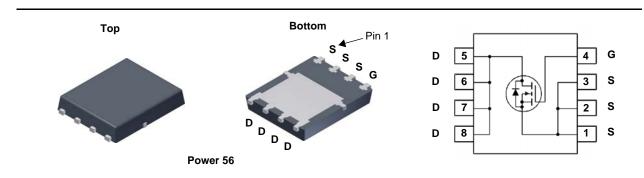


## **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench<sup>®</sup> process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

### Applications

- Primary DC-DC
- Secondary DC-DC
- Load Switch



### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter		Ratings	Units		
V <sub>DS</sub>	Drain to Source Voltage		100	V		
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
I <sub>D</sub>	Drain Current -Continuous (Package limited) T <sub>C</sub> = 25 °C		56	A		
	-Continuous (Silicon limited) $T_C = 25 \text{ °C}$		26			
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	6	— A	
	-Pulsed		30			
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	50	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		48	W	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5	VV	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C		
Thermal Ch	naracteristics					
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case			2.6	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	Thermal Resistance, Junction to Ambient (Note 1a)			C/vv	

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86105	FDMS86105	Power 56	13 "	12 mm	3000 units

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	acteristics			1		
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		70		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 80 V, V_{GS} = 0 V$			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20$ V, $V_{DS} = 0$ V			±100	nA
On Chara	acteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	2.0	2.8	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-9		mV/°C
		$V_{GS} = 10 V, I_D = 6 A$		27	34	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 6 V, I_D = 4.5 A$		37	54	mΩ
		$V_{GS}$ = 10 V, $I_D$ = 6 A, $T_J$ = 125 °C		46	57	
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 10 V, I_{D} = 6 A$		15		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			483	645	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V},$		114	155	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1 MHz		5	10	pF
R <sub>g</sub>	Gate Resistance			0.9		Ω
*	a Characteristics		I		1	I
	g Characteristics			0.7	4.4	
t <sub>d(on)</sub>	Turn-On Delay Time			6.7	14	ns
t <sub>r</sub>	Rise Time	$V_{DD}$ = 50 V, I <sub>D</sub> = 6 A, V <sub>GS</sub> = 10 V, R <sub>GEN</sub> = 6 Ω		2.1	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10^{-0}$ , $K_{GEN} = 0.22$		12	22	ns
t <sub>f</sub>	Fall Time			2.4	10	ns
Q <sub>g</sub>	Total Gate Charge	$V_{GS} = 0$ V to 10 V		7.5	11	nC
Q <sub>g</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V$ $V_{DD} = 50 V$ , $I_D = 6 A$		4.2	6	nC
Q <sub>gs</sub>	Gate to Source Charge	1 <sub>D</sub> = 0 A		2.1		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			1.7		nC
Drain-So	urce Diode Characteristics				[	r
V <sub>SD</sub>	Source-Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.76	1.2	v
	-	$V_{GS} = 0 V, I_S = 6 A$ (Note 2)		0.82	1.3	<b> </b>
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 6 A, di/dt = 100 A/μs		38	61	ns
Q <sub>rr</sub>	Reverse Recovery Charge			32	51	nC
2. Pulse Test: P	ard design. a. 50 °C/W when mour 1 in <sup>2</sup> pad of 2 oz co 00000 00000 vulse Width < 300 μs, Duty cycle < 2.0%.			en mounted of 2 oz cop		
3. Starting T <sub>J</sub> =	25 °C, L = 1 mH, I <sub>AS</sub> = 10 A, V <sub>DD</sub> = 90 V, V <sub>GS</sub> = 10 V.					

**Test Conditions** 

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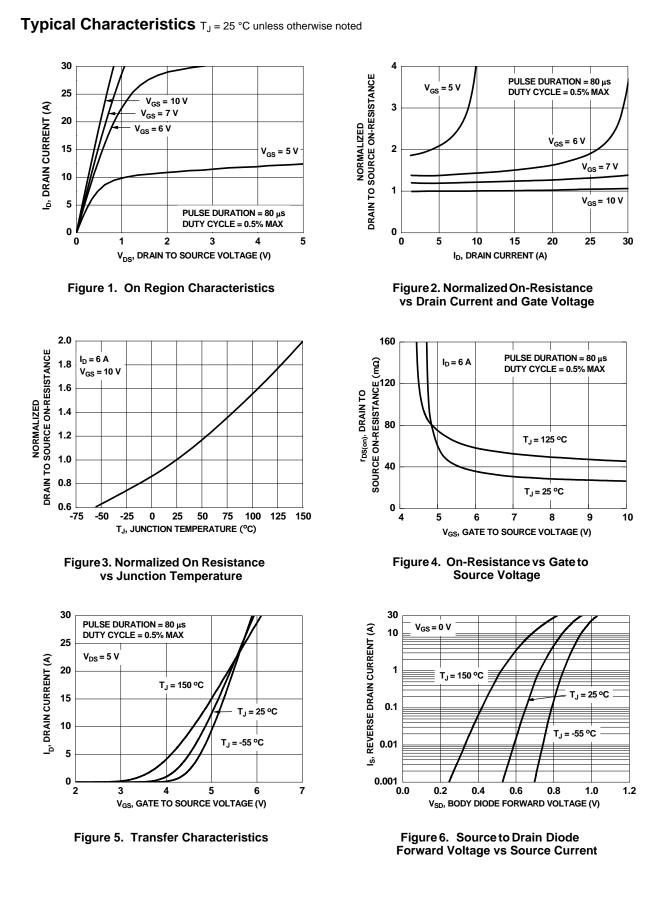
Max

Units

**Electrical Characteristics**  $T_J = 25 \text{ °C}$  unless otherwise noted

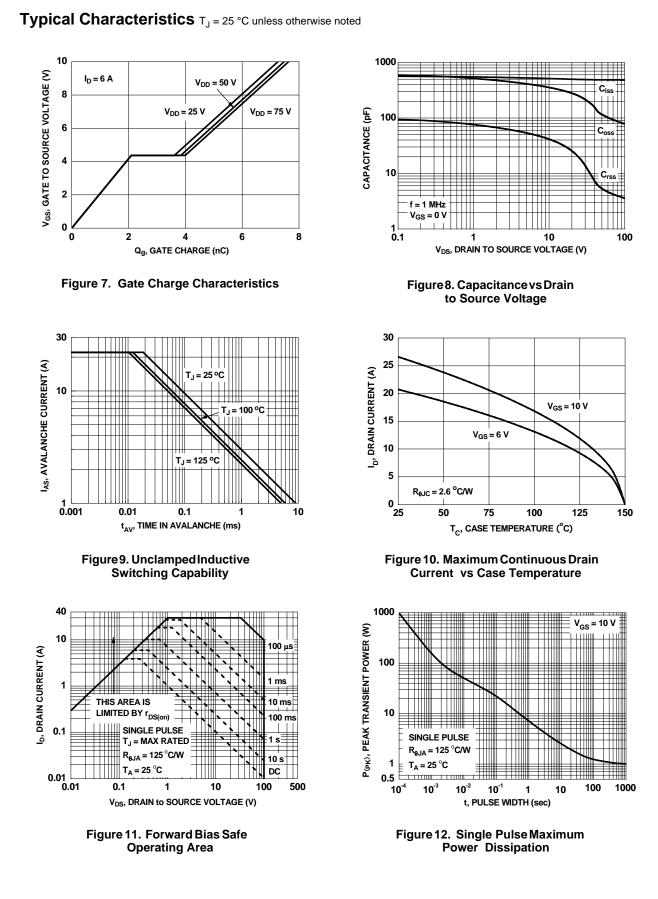
Parameter

Symbol

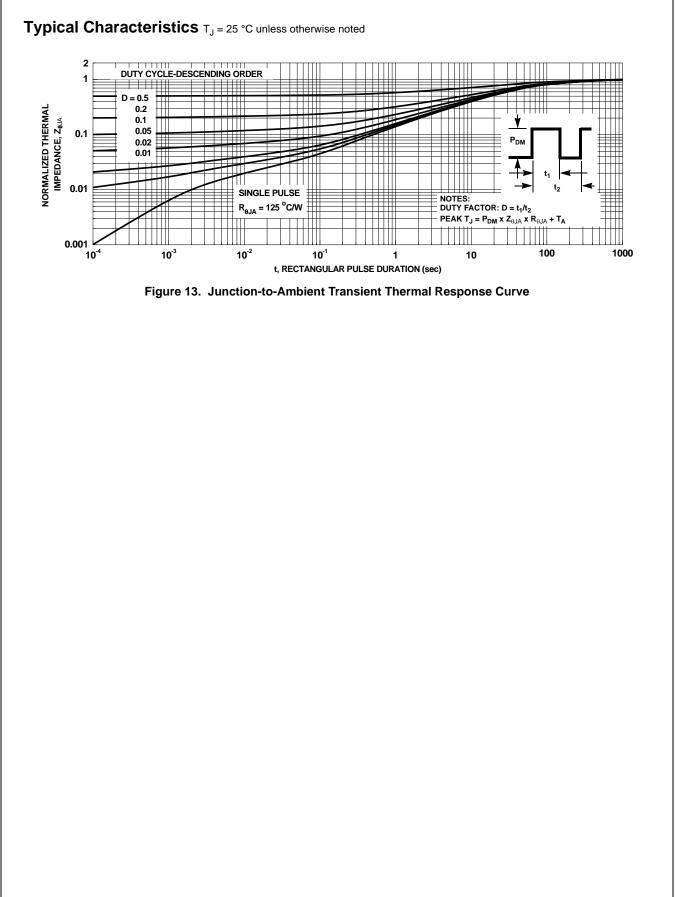


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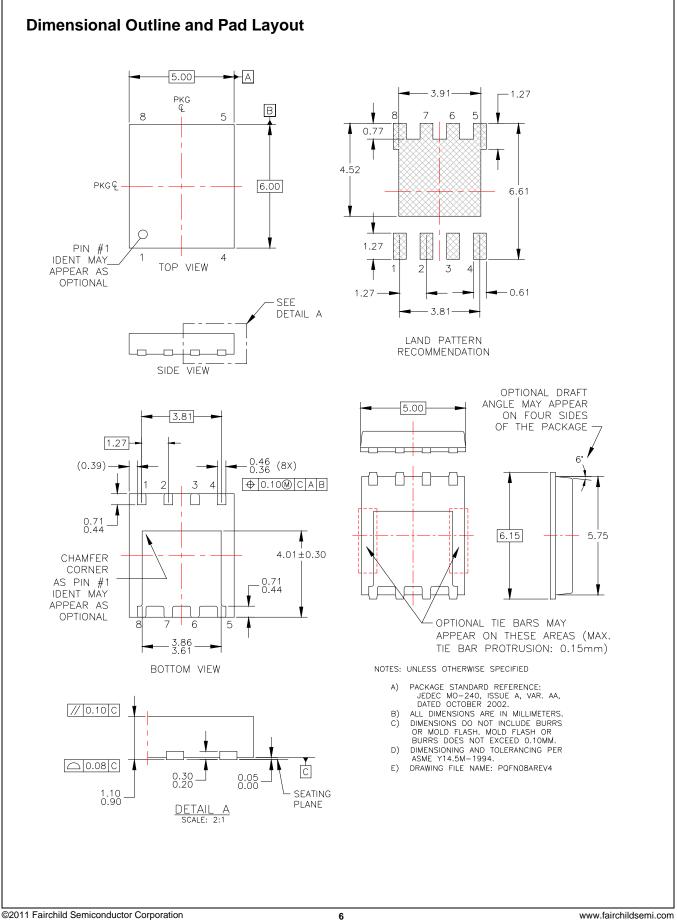




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